



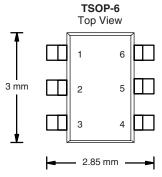
P-Channel 2.5-V (G-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
- 20	0.090 at V _{GS} = - 4.5 V	- 2.9		
	0.130 at V _{GS} = - 2.5 V	- 2.45		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFETs
- · Compliant to RoHS Directive 2002/95/EC

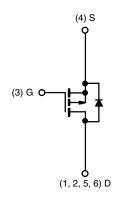




Ordering Information: Si3441BDV-T1-E3 (Lead (Pb)-free)

Si3441BDV-T1-GE3 (Lead (Pb)-free and Halogen-free)

Marking Code: B1xxx



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 20		V
Gate-Source Voltage		V _{GS}	± 8		
Continuous Dusin Comment /T 450 900	T _A = 25 °C	I _D	- 2.9	- 2.45	Δ.
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 2.35	-1.95	
Pulsed Drain Current		I _{DM}	- 16		Α
Continuous Source Current (Diode Conduction) ^a		I _S	- 1.0	- 0.72	
Mariana Barra Birata da A	T _A = 25 °C	P _D	1.25	0.86	W
Maximum Power Dissipation ^a	T _A = 70 °C		0.8	0.55	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian una lumation ta Analianta	t ≤ 5 s	- R _{thJA}	80	100	°C/W
Maximum Junction-to-Ambient ^a	Steady State		120	145	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	70	85	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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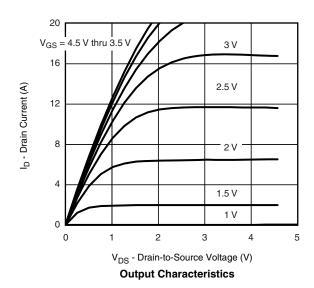
SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions Mir		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.45		- 0.85	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zana Oata Walkana Busin Oamaal	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V	- 1		- 1		
Zero Gate Voltage Drain Current		V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 70 °C			- 5	μΑ	
0.00.00.00.00		V _{DS} = - 5 V, V _{GS} = - 4.5 V	- 10			Α	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 2.5 V	- 4				
	В	V _{GS} = - 4.5 V, I _D = - 3.3 A		0.070	0.090		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 2.9 A		0.098	0.130	130	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 3.3 A		8.0		S	
Diode Forward Voltage ^a	V _{SD}	I _S = - 1.6 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Dynamic ^b							
Total Gate Charge	Q_g			5.2	8.0	nC	
Gate-Source Charge	Q_{gs}	Q_{gs} $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -3.3 \text{ A}$		0.8			
Gate-Drain Charge	Q_{gd}			1.5			
Turn-On Delay Time	t _{d(on)}			15	25		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		55	85	ns	
Turn-Off Delay Time	t _{d(off)}	$I_{D} \cong -1.0 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_{g} = 6 \Omega$		30	45		
Fall Time	t _f			40	60		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.6 A, dI/dt = 100 A/μs		50	80		

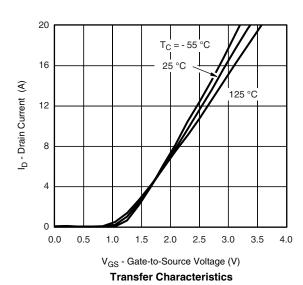
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



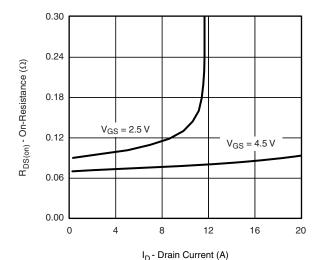




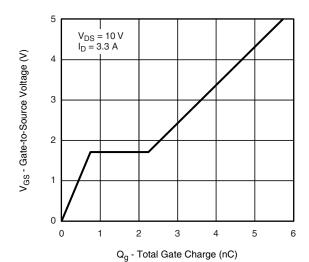




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



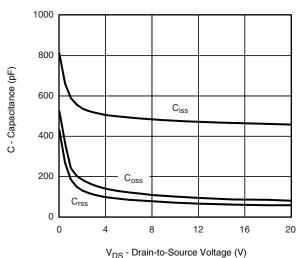
On-Resistance vs. Drain Current



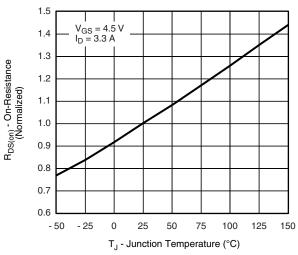
20 T_J = 150 °C 10 I_S - Source Current (A) $T_J = 25$ °C 0.0 0.2 0.4 0.6 8.0 1.0 1.2 1.4

Gate Charge

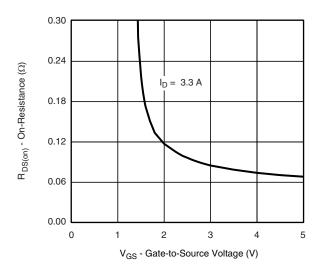
V_{SD} - Source-to-Drain Voltage (V) Source-Drain Diode Forward Voltage







On-Resistance vs. Junction Temperature

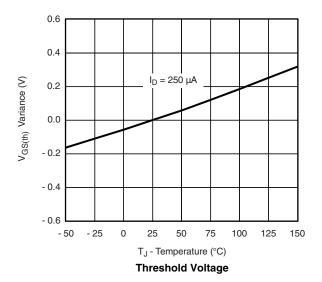


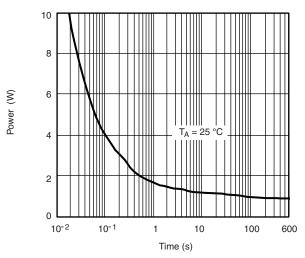
On-Resistance vs. Gate-to-Source Voltage

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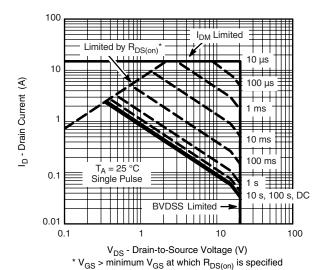
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

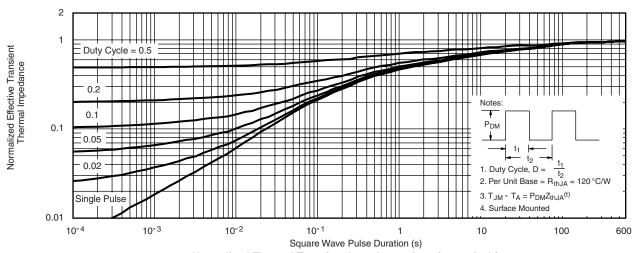




Single Pulse Power



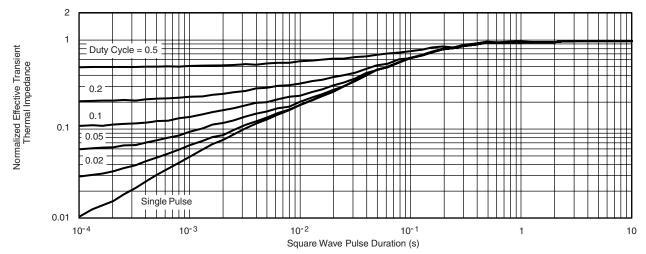
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

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